Advanced Semiconductor Engineering, Inc.



FOR IMMEDIATE RELEASE

Contact: ASE, Inc.

Room 1901, No. 333, Section 1 Keelung Road, Taipei, Taiwan, 110 Freddie Liu, Vice President ir@aseglobal.com

Tel: + 886.2.8780.5489 Fax: + 886.2.2757.6121 http://www.aseglobal.com

ADVANCED SEMICONDUCTOR ENGINNERING, INC. PRESS RELEASE

April 17, 2007, Taipei, Taiwan — Advance Semiconductor Engineering, Inc. (TAIEX: 2311, NYSE: ASX) ("ASE" or the "Company") announced today that it was notified by the investor consortium led by The Carlyle Group (the "Consortium") that the Consortium would withdraw its plans, originally announced by the Consortium on November 24, 2006, to make an offer to acquire 100% of the outstanding shares of the Company at NT\$39 per share (the "Proposed Offer").

The Consortium stated that the reason for withdrawing the Proposed Offer was the inability of the Consortium and the evaluation committee formed by Director T.C. Cheng at the request of the Company's Board of Directors (the "Evaluation Committee") to reach agreement on the proposed offer price after a number of meetings between the Evaluation Committee.

During its most recent meeting with the Evaluation Committee, the Consortium agreed to increase the offer price to NT\$39.50 per share. The Evaluation Committee concluded that this proposed offer price did not reflect the value of the Company and informed the Board of the Company and the Consortium that it would not support a transaction at the proposed offer price. Following this, the Company received a letter from the Consortium today (April 17, 2007) stating that the Consortium had determined not to pursue the proposed transaction.

Safe Harbor Notice

This press release contains "forward-looking statements" within the meaning of Section 27A of the Securities Act of 1933, as amended, and Section 21E of the Securities Exchange Act of 1934, as amended. Although these forward-looking statements, which may include statements regarding our future results of operations, financial condition or business prospects, are based on our own information and information from other sources we believe to be reliable, you should not place undue reliance on these forward-looking statements, which apply only as of the date of this press release. The words "anticipate", "believe", "estimate", "expect", "intend", "plan" and similar expressions, as they relate to us, are intended to identify these forward-looking statements in this press release. Our actual results of operations, financial condition or business prospects may differ materially from those expressed or implied in these forward-looking statements for a variety of reasons, including risks associated with cyclicality and market conditions in the semiconductor industry; demand for the outsourced semiconductor packaging and testing services we offer and for such outsourced services generally; the highly competitive semiconductor industry; our ability to introduce new packaging, interconnect materials and testing technologies in order to remain competitive; our ability to successfully integrate pending and future mergers and acquisitions; international business activities; our business strategy; general economic and political conditions; possible disruptions in commercial activities caused by natural or human-induced disasters; our future expansion plans and capital expenditures; the strained relationship between the Republic of China and the People's Republic of China; fluctuations in foreign currency exchange rates; and other factors. For a discussion of these risks and other factors, please see the documents we file from time to time with the Securities and Exchange Commission, including our 2005 Annual Report on Form 20-F filed on June 19, 2006.